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CENTRAL FAX CENTER****JUN 27 2006****CHIP-PACKAGING WITH BONDING OPTIONS CONNECTED TO A
PACKAGE SUBSTRATE**

Appl. No.	:	10/709,428	Confirmation No.	3427
Applicant	:	Cheng-Yen Huang		
Filed	:	May 5, 2004		
TC/A.U.	:	2814		
Examiner	:	TRINH, HOA B		
Docket No.	:	FTCP0035USA0		
Customer No.	:	27765		

Commissioner for Patents
P.O. Box 1450
Alexandria VA 22313-1450

AMENDMENT AND REQUEST FOR CONTINUED EXAMINATION

5 Sir:

In response to the Advisory action of May 17, 2006, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

10 Remarks/Arguments begin on page 4 of this paper.